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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
YOSHIHIRO HAMABE	04/30/2015	
TAKURO ISHIKAWA	04/30/2015	

RECEIVING PARTY DATA

Name:	KABUSHIKI KAISHA SAGINOMIYA SEISAKUSHO		
Street Address:	55-5, WAKAMIYA 2-CHOME		
Internal Address:	NAKANO-KU		
City:	TOKYO		
State/Country:	JAPAN		
Postal Code:	165-8907		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14441039

CORRESPONDENCE DATA

Fax Number: (703)683-1080

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

703-683-0500 Phone:

Email: uspto@baconthomas.com

JUAN CARLOS A. MARQUEZ BACON & THOMAS PL **Correspondent Name:**

Address Line 1: 625 SLATERS LANE

Address Line 2: 4TH FLOOR

Address Line 4: ALEXANDRIA, VIRGINIA 22314-1176

ATTORNEY DOCKET NUMBER: **TAKI-0012 NAME OF SUBMITTER:** JUAN CARLOS A. MARQUEZ SIGNATURE: /juan.carlos.a.marquez/ **DATE SIGNED:** 05/06/2015

Total Attachments: 2

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> **PATENT** REEL: 035577 FRAME: 0374 503295115

ASSIGNMENT

WHEREAS, I/We, whose names and post office addresses appear below hereinafter referred to as ASSIGNOR, have invented certain new and useful improvements in

WELD STRUCTURE FOR REFRIGERANT CIRCUIT COMPONENT AND WELDING METHOD FOR REFRIGERANT CIRCUIT COMPONENT (hereinafter referred to as THE INVENTION) which I/We made, contributed to the making and/or authorized the making of an application for the above-noted subject matter which is claimed and for which a patent is sought on the invention (design, if applicable) and I/We believe that I/We are the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a United States Letters Patent is sought on the invention (design, if applicable);

WHEREAS, an appl	lication for United	States Letters	Patent or	for priority	under 1	International	Convention
for the above-noted subject m	natter is being filed	l concurrently	herewith,	or was filed	on		
under Application Number			,				

WHEREAS, <u>Kabushiki Kaisha Saginomiya Seisakusho</u>, whose post office address is <u>55-5</u>, <u>Wakamiya 2-chome</u>, <u>Nakano-ku</u>, <u>Tokyo 165-8907 Japan</u> (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title and interest in and to the same in the United States and throughout the world;

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, we, ASSIGNOR, by these presents do sell, assign and transfer until said ASSIGNEE, the entire right, title and interest in and to said invention and application throughout the United States of America, including any and all United States Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application; and the entire right, title and interest in and to said invention throughout the world, including the right to apply for patents and inventor certificates in respect thereof and to claim priority pursuant to rights accorded ASSIGNOR under the terms of the Paris International Convention and all other available international conventions and treaties; and the entire right, title and interest in and to any and all patents, patents of addition, utility models, patents of importation, revalidation patents and inventor certificates which may be granted throughout the world in respect of said invention.

ALSO, ASSIGNOR here by agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) or inventor certificate(s) in the United States and in foreign countries for said invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE'S request documents and information concerning the invention that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent referred to above to ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE'S sole use and behalf; and for the use and behalf of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

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ASSIGNOR hereby declares that all statements made herein of my/our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine, or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

NAME:	Yoshihiro HAMABE	Edamale
		Signature April 30, 2015 Date
ADDRESS:	c/o Kabushiki Kaisha Saginomiya Seisakusho,	Date
	Sayama Jigyosho, 535, Sasai, Sayama-shi,	
	Saitama 350-1395, Japan	
NAME:	Takuro ISHIKAWA	Takuro ISHIKAWA Signature April 30, 2015
ADDRESS:	c/o Kabushiki Kaisha Saginomiya Seisakusho,	Date
	Sayama Jigyosho, 535, Sasai, Sayama-shi,	
	Saitama 350-1395, Japan	
NAME:		
ADDRESS:		Signature
		Date
NAME: ADDRESS:		Signature
		Date

PATENT REEL: 035577 FRAME: 0376

RECORDED: 05/06/2015